For over 30 years Diamond Systems has been delivering embedded computing boards and systems to customers in a variety of industries around the globe. During this time, our products and services have been utilized in virtually every industry and region around the world. Our specialties are:

- Compact, rugged, and I/O rich designs
- Nvidia Jetson carrier boards and systems
- Managed Ethernet switches with 1G and 10G speeds
- x86 single-board computers and I/O
- Cost-effective rugged systems
- Custom solutions based on our areas of technology expertise

While our standard product offerings fill a wide range of needs effectively, our custom solutions service takes embedded computing to the next level by delivering low minimum quantity, perfect-fit solutions drawing on our experience, expertise, and global supply chain to help our customers achieve better performance and competitiveness.

Global Value Chain

Diamond’s extensive global supply base allows us to take advantage of a wider range of design and manufacturing expertise, utilize the latest manufacturing equipment and methods, and gain access to far higher production capacity than companies who try to do it all in house. We are able to meet varying customer needs ranging from small volume or ITAR compliance up to high volume, cost optimized design and manufacturing. Diamond serves as the solution provider, bringing appropriate talent, services, and suppliers together to deliver the best solution for your project, without the limitation of reliance on captive resources.

The products and solutions shown here are a sampling of our overall offering. Please visit our website to learn more or contact us directly: sales@diamondsystems.com
Diamond’s NVIDIA Jetson product line features solutions for the complete Jetson product line at every level of integration: Carriers, carriers with Jetson module and thermal solution installed, and full systems. Our extensive carrier board design experience serves as the basis for many custom carrier board projects for customers around the world and helps to reduce design time and risk. Diamond was the first company to combine NVIDIA Jetson high-performance AI-at-the-edge computing with high performance rugged PCIe/104 expansion.

**NVIDIA® JETSON SOLUTIONS**

COMING SOON!

**OSBOURNE** carrier for Jetson AGX Orin:
- 10Gbps Ethernet
- Multiple M.2 / mPCIe expansion sockets
- Camera adapter with 16 MIPI CSI lanes
- I/O concentrator connector for flexible system integration with standard & custom connector boards

**FLOYD-SC**
- Carrier for Nano / NX / TX2 NX
- Compact size 4.3x3.3”
- Cost effective
- Expandable with daughterboard

**STEVIE**
- Carrier for AGX Xavier
- Single/dual Ethernet
- Rich I/O
- Compact size 3.6x4.2”

**COMING SOON!**

**OSBOURNE** carrier for Jetson AGX Orin:
- 10Gbps Ethernet
- Multiple M.2 / mPCIe expansion sockets
- Camera adapter with 16 MIPI CSI lanes
- I/O concentrator connector for flexible system integration with standard & custom connector boards

**JETBOX**
- Complete systems for Diamond NVIDIA carriers
- Include Jetson module and OS loaded
- Ready to run
- Up to 6 GMSL cameras

**ETHERNET SWITCHES**

Diamond’s **Epsilon** line of Ethernet switches provide compact, convenient, industrial/military grade solutions for managed gigabit Ethernet switching.
- Layer 2 / Layer 3 switching / routing capability with feature-rich embedded software
- Up to 24 1G ports + 4 10G ports on a single rugged board
- In-band web GUI and out-of-band serial port interfaces
- IEEE 1588 / PTP capability available on most products
- Embedded software can be customized with your own branding
- Latching connectors, thicker PCBs, and industrial -40/+85C operating temperature
- Qualified to MIL standards for shock and vibration

**Ethernet Switch Modules**

Our EPSM Ethernet switch modules provide compact off-the-shelf solutions that eliminate 95% of the design effort and risk for a custom managed Ethernet switch. Customers have the flexibility to define their own form factor and connectors while enjoying vastly reduced development time and cost.

**EPS-8130**
- 8 Gbe ports
- Latching connectors
- Layer 2+ management
- Heat sink / heat spreader option

**EPS-24G4X**
- 24 1Gbps ports
- 4 10Gbps SFP+
- Conduction cooling
- Layer 3 routing
- IEEE-1588 PTP

**COMING SOON!**

**FLOYD-SC**
- Carrier for Nano / NX / TX2 NX
- Compact size 4.3x3.3”
- Cost effective
- Expandable with daughterboard

**STEVIE**
- Carrier for AGX Xavier
- Single/dual Ethernet
- Rich I/O
- Compact size 3.6x4.2”

**JETBOX**
- Complete systems for Diamond NVIDIA carriers
- Include Jetson module and OS loaded
- Ready to run
- Up to 6 GMSL cameras

**COMING SOON!**

**OSBOURNE** carrier for Jetson AGX Orin:
- 10Gbps Ethernet
- Multiple M.2 / mPCIe expansion sockets
- Camera adapter with 16 MIPI CSI lanes
- I/O concentrator connector for flexible system integration with standard & custom connector boards

**JETBOX**
- Complete systems for Diamond NVIDIA carriers
- Include Jetson module and OS loaded
- Ready to run
- Up to 6 GMSL cameras

**COMING SOON!**

**OSBOURNE** carrier for Jetson AGX Orin:
- 10Gbps Ethernet
- Multiple M.2 / mPCIe expansion sockets
- Camera adapter with 16 MIPI CSI lanes
- I/O concentrator connector for flexible system integration with standard & custom connector boards

**JETBOX**
- Complete systems for Diamond NVIDIA carriers
- Include Jetson module and OS loaded
- Ready to run
- Up to 6 GMSL cameras

**COMING SOON!**

**OSBOURNE** carrier for Jetson AGX Orin:
- 10Gbps Ethernet
- Multiple M.2 / mPCIe expansion sockets
- Camera adapter with 16 MIPI CSI lanes
- I/O concentrator connector for flexible system integration with standard & custom connector boards

**JETBOX**
- Complete systems for Diamond NVIDIA carriers
- Include Jetson module and OS loaded
- Ready to run
- Up to 6 GMSL cameras
Diamond has a diverse line of small form factor SBCs targeting rugged and I/O-rich applications. Product highlights demonstrate our commitment to ruggedness and I/O:

- Integrated conduction cooling mounting plates for efficient thermal dissipation
- Latching connectors and thicker PCBs
- Integrated data acquisition
- Wide temperature -40 to +85°C operation

**Compact SBCs** offer rugged performance with rich I/O and flexible expansion in a small size.

**2-in-1 SBCs** with integrated professional quality analog and digital I/O circuits save space for applications requiring real-world I/O.

**COM Express SBCs** consist of a carrier board in an industry-standard form factor with a COM Express module installed to provide the CPU function. This integrated design provides scalable performance and extended lifetime through the use of interchangeable COMs, while the expansion sockets support easy I/O customization to fit each application.

**I/O EXPANSION**

**Rugged PC/104 I/O Modules** provide easy off-the-shelf I/O expansion for embedded systems requiring ruggedness and a high level of I/O.

- Analog I/O with autocalibration and programming library
- Digital I/O with counter/timers and PWM
- Serial ports with RS-232/422/485 capability
- Relay and opto-isolated I/O
- CAN ports
- Custom designs

**PCle Minicards**

These cost-effective modules offer economical I/O expansion in a popular ultra-compact form factor.
SABRE systems provide economical rugged solutions for Diamond's embedded SBCs (SabreCom) and Ethernet switches (SabreNet). These systems can be easily customized with rugged power supplies and additional I/O to meet application requirements. These systems feature IP67 environmental protection and MIL-STD-202G shock/vibration ratings. MIL-STD-461 / 1275 / 704 power supply compatibility is available on all products. SabreNet switches feature 1G and 10G data rates with both copper and fiber capability.

GEODE is Diamond's newest rugged system family offering quicker time to market and easier I/O expansion. Geode features a cable-free design for increased ruggedness and expansion-ready I/O connectors to simplify I/O customization. The COM Express-based architecture supports multiple processor options for scalable performance and increased product lifetime.

CUSTOM SOLUTIONS

Diamond's custom solutions program offers perfect-fit board, subassembly, and system solutions based on x86, Nvidia Jetson, and Ethernet switch technologies.

- Our extensive design experience in all three domains enables us to define an optimal architecture, choose the best components, and implement the ideal physical form factor based on customer priorities and current industry conditions.
- We utilize industry-standard technologies and form factors wherever possible to enable quicker time to market, greater flexibility, and longer lifetime.
- In today's difficult supply chain conditions, a custom solution also provides improved cost and manufacturability by designing out older components and technologies and selecting newer ones with better performance, availability, and lifetime.
- Program includes modifications to standard products to optimize them for customer applications.